UUT

6mmL Chip Type, Wide Temperature Range





- Chip type with load life 2000 hours at +105°C.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU).

Values marked with an % in the dimension table are scheduled to be discontinued and are not recommended for new designs.

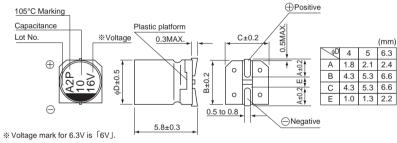




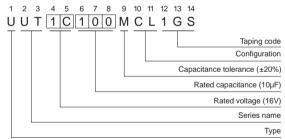
Specifications

Item	Performance Characteristics													
Category Temperature Range	−55 to +105°C													
Rated Voltage Range	4 to 50V													
Rated Capacitance Range	0.1 to 100μF													
Capacitance Tolerance	±20% at 120Hz, 20°C													
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01 CV or 3 (µA), whichever is greater.													
	Measurement frequency :120Hz at 20°C													
Tangent of loss angle (tan δ)	Rated voltage (V)	4	6.3		10	16	2	5	3	5	50			
	tan δ (MAX.)	0.37	0.28	3	0.24	0.20	0.	16	0.	13	0.12			
	Measurement frequency :120Hz													
Chalifity at Law Tarrage and the	Rated voltage (V)		4	6.3	10	16		25	35	50				
Stability at Low Temperature	Impedance ratio	Z-25°C / Z		6	3	3	2		2	2	2			
	ZT / Z20 (MAX.)	Z-40°C / Z	Z+20°C	12	8	5	4		3	3	3			
	The specifications I		l '			Within ±25% of the initial capacitance value (16V or less) Within ±20% of the initial capacitance value (25V or more)								
Endurance	when the capacitors are restored to 20°C after the rated voltage is applied for 2000 hours at					tan δ			200% or less than the initial specified value					
	105°C. Leakage current Less than or equal to the initial specified value													
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.													
	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.							Capacitance change		e Within :	Within ±10% of the initial capacitance value			
Resistance to soldering								tan δ				Less than or equal to the initial specified value		
heat								Leakage current Less than or equal to the				an or equal to the initial specified value		
Marking	Black print on the c	ase top.												

■Chip Type



Type numbering system (Example : $16V 10\mu F$)



Dimensions

	V	4		6.	3	10)	16	ô	2	5	35	5	50)
Cap.(µF)	Code	00	3	0.	J	1/	4	10)	16	=	1\	/	1F	1
0.1	0R1								1				1	*4	1.0
0.22	R22								i I		i I		i I	* 4	2.6
0.33	R33						!		!		! !		!	* 4	3.2
0.47	R47								! !				! !	* 4	3.8
1	010						i I		i I		i I		i I	4	6.2
2.2	2R2						l I		! !		!		! !	4	11
3.3	3R3													4	14
4.7	4R7		i I				i I		i I	4	13	4	i 15	5	19
10	100						 	4	18	5	23	5	25	6.3	30
22	220	4	22	4	22	5	27	5	30	6.3	38	6.3	42		
33	330	5	30	5	30	5	35	6.3	l 40	6.3	48		l I		
47	470	5	36	5	36	6.3	46	6.3	50						Rated
100	101	6.3	60	6.3	60	6.3	60		İ		l I		İ	Case size φ D (mm)	ripple

Rated ripple current (mArms) at 105°C 120Hz

Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more	
Coefficient	0.70	1.00	1.17	1.36	1.50	

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please select UUX(p.152), UUJ(p.158) if high C/V products are required.
- Please refer to page 3 for the minimum order quantity.